

## Standard Rectifier Module

$$V_{RRM} = 2 \times 1600 \text{ V}$$

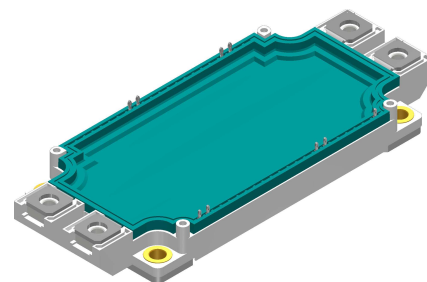
$$I_{FAV} = 425 \text{ A}$$

$$V_F = 1.21 \text{ V}$$

Phase leg + NTC

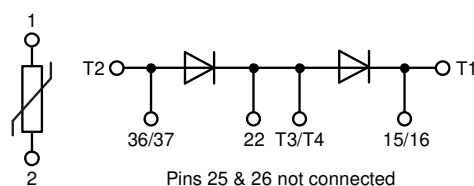
Part number

**MDMA425P1600PTSF**



Backside: isolated

 E72873



### Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

### Applications:

- Diode for main rectification
- For single and three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

### Package: SimBus F

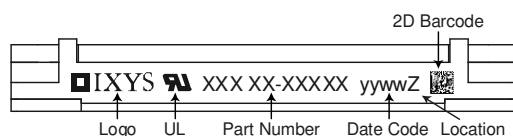
- Isolation Voltage: 4300 V~
- Industry standard outline
- RoHS compliant
- PressFit-Pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

### Disclaimer Notice

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| Rectifier  |                                              |                                                      |                                | Ratings                        |      |       |                   |
|------------|----------------------------------------------|------------------------------------------------------|--------------------------------|--------------------------------|------|-------|-------------------|
| Symbol     | Definition                                   | Conditions                                           |                                | min.                           | typ. | max.  | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}\text{C}$                        |                                |                                |      | 1700  | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}\text{C}$                        |                                |                                |      | 1600  | V                 |
| $I_R$      | reverse current                              | $V_R = 1600\text{ V}$                                | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 300   | $\mu\text{A}$     |
|            |                                              | $V_R = 1600\text{ V}$                                | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 8     | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 425\text{ A}$                                 | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 1.29  | V                 |
|            |                                              | $I_F = 850\text{ A}$                                 |                                |                                |      | 1.65  | V                 |
|            |                                              | $I_F = 425\text{ A}$                                 | $T_{VJ} = 125^{\circ}\text{C}$ |                                |      | 1.21  | V                 |
|            |                                              | $I_F = 850\text{ A}$                                 |                                |                                |      | 1.64  | V                 |
| $I_{FAV}$  | average forward current                      | $T_C = 100^{\circ}\text{C}$<br>rectangular $d = 0.5$ | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 425   | A                 |
| $V_{F0}$   | threshold voltage                            | } for power loss calculation only                    |                                | $T_{VJ} = 150^{\circ}\text{C}$ |      | 0.77  | V                 |
| $r_F$      | slope resistance                             |                                                      |                                |                                |      | 1.01  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                                      |                                |                                |      | 0.07  | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                                      |                                |                                | 0.04 |       | K/W               |
| $P_{tot}$  | total power dissipation                      | $T_C = 25^{\circ}\text{C}$                           |                                |                                |      | 1785  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$     | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 10.0  | kA                |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$    | $V_R = 0\text{ V}$             |                                |      | 10.8  | kA                |
|            |                                              | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$     | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 8.50  | kA                |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$    | $V_R = 0\text{ V}$             |                                |      | 9.18  | kA                |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$     | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 500.0 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$    | $V_R = 0\text{ V}$             |                                |      | 485.2 | kA <sup>2</sup> s |
|            |                                              | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$     | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 361.3 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$    | $V_R = 0\text{ V}$             |                                |      | 350.6 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400\text{ V}; f = 1\text{ MHz}$               |                                |                                | 661  |       | pF                |

| Package SimBus F |                                                              |                      |                                     | Ratings |      |      |      |
|------------------|--------------------------------------------------------------|----------------------|-------------------------------------|---------|------|------|------|
| Symbol           | Definition                                                   | Conditions           |                                     | min.    | typ. | max. | Unit |
| $I_{RMS}$        | RMS current                                                  | per terminal         |                                     |         |      | tbd  | A    |
| $T_{VJ}$         | virtual junction temperature                                 |                      |                                     | -40     |      | 175  | °C   |
| $T_{op}$         | operation temperature                                        |                      |                                     | -40     |      | 150  | °C   |
| $T_{stg}$        | storage temperature                                          |                      |                                     | -40     |      | 125  | °C   |
| <b>Weight</b>    |                                                              |                      |                                     |         | 350  |      | g    |
| $M_D$            | mounting torque                                              |                      |                                     | 3       |      | 6    | Nm   |
| $M_T$            | terminal torque                                              |                      |                                     | 3       |      | 6    | Nm   |
| $d_{Spp/App}$    | creepage distance on surface   striking distance through air | terminal to terminal | 13.3                                | 10.0    |      |      | mm   |
| $d_{Spp/Apb}$    |                                                              | terminal to backside | 10.2                                | 10.2    |      |      | mm   |
| $V_{ISOL}$       | isolation voltage                                            | t = 1 second         | 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA | 4300    |      |      | V    |
|                  |                                                              | t = 1 minute         |                                     | 3600    |      |      | V    |



### Part description

M = Module  
 D = Diode  
 M = Standard Rectifier  
 A = (up to 1800V)  
 425 = Current Rating [A]  
 P = Phase leg  
 1600 = Reverse Voltage [V]  
 PT = PressFit-Pin, Thermistor  
 SF = SimBus F  
 - = Hyphen  
 PC = Phase Change Material

| Ordering    | Ordering Number     | Marking on Product | Delivery Mode | Quantity | Code No. |
|-------------|---------------------|--------------------|---------------|----------|----------|
| Standard    | MDMA425P1600PTSF    | MDMA425P1600PTSF   | Blister       | 24       | 519078   |
| Alternative | MDMA425P1600PTSF-PC | MDMA425P1600PTSF   | Blister       | 24       | 519057   |

| Similar Part     | Package  | Voltage class |
|------------------|----------|---------------|
| MDMA300P1600PTSF | SimBus F | 1600          |
| MDMA600P1600PTSF | SimBus F | 1600          |
| MDNA300P2200PTSF | SimBus F | 2200          |
| MDNA600P2200PTSF | SimBus F | 2200          |

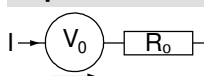
### Temperature Sensor NTC

| Symbol      | Definition              | Conditions          | min. | typ. | max. | Unit       |
|-------------|-------------------------|---------------------|------|------|------|------------|
| $R_{25}$    | resistance              | $T_{VJ} = 25^\circ$ | 4.85 | 5    | 5.15 | k $\Omega$ |
| $B_{25/50}$ | temperature coefficient |                     |      | 3375 |      | K          |

### Equivalent Circuits for Simulation

\* on die level

$T_{VJ} = 150^\circ\text{C}$



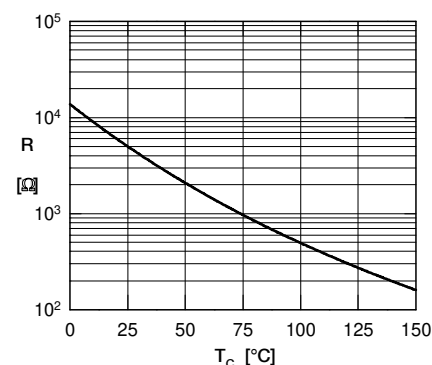
Rectifier

$V_{0\max}$  threshold voltage 0.77

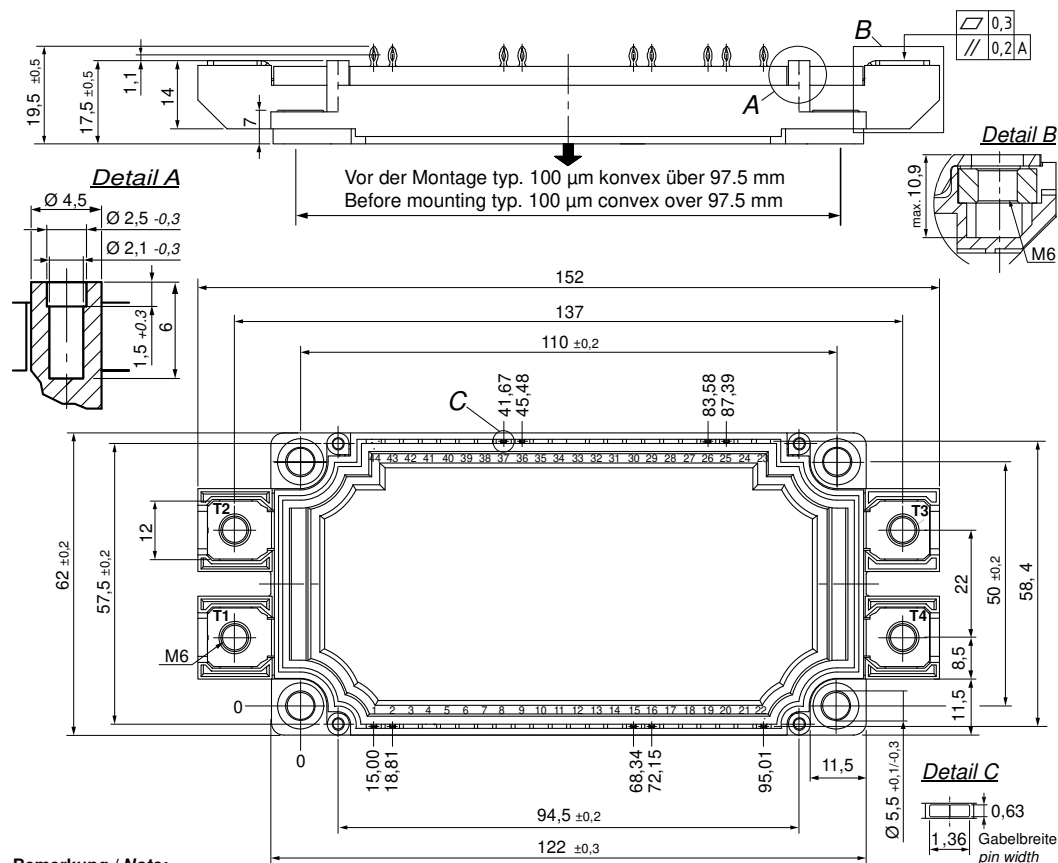
$R_{0\max}$  slope resistance \* 0.29

V

m $\Omega$



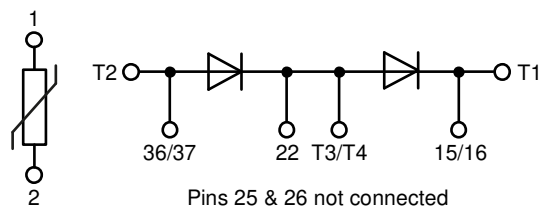
Typ. NTC resistance vs. temperature

**Outlines SimBus F**

**Bemerkung / Note:**

- Nichttolerierte Maße nach / Measure w/o tolerances acc. DIN ISO 2768-T1-m
- PCB-Lochmuster / PCB hole pattern: see pin position
- Toleranz Pin-Position und PCB-Lochmuster / Tolerance of pin position and PCB hole pattern:  $\oplus 0,1$
- Bohrlochdurchmesser / Diameter of drill: Ø 1.16 mm
- Endlochdurchmesser / Diameter of plated holes: Ø 1.00 - 1.10 mm (Cu thickness in via typ. 50 µm)
- Beschichtung / Plating: chem. Sn max. 15 µm
- Einpresskraft / Insert Force: per terminal with a typ. insert speed of 1 mm/s: typ. 90 N
- Weitere Angaben / Further information: [www.ixys.com](http://www.ixys.com) Application note IXAN0077
- Montageanleitung / Mounting instruction: [www.ixys.com](http://www.ixys.com) Application note IXAN0024

**Detail A: PCB-Montage / Mounting on PCB<sup>L</sup>**

- Empfohlene, selbstschneidende Schraube / Recommended, self-tapping screw: **EJOT PT®** (Größe / size: **K25**)<sup>L</sup>
- Max. Schraubenlänge / Max. screw length: **PCB-Dicke / thickness + 6 mm** (max. Lochtiefe / hole depth)<sup>L</sup>
- Empfohlenes Drehmoment / Recommended mounting torque: **1.5 Nm**



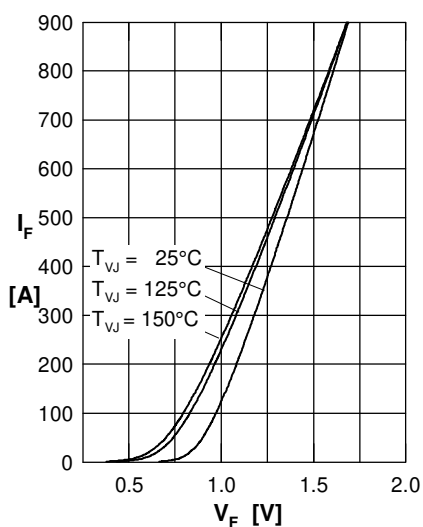
**Rectifier**


Fig. 1 Forward current versus voltage drop per diode

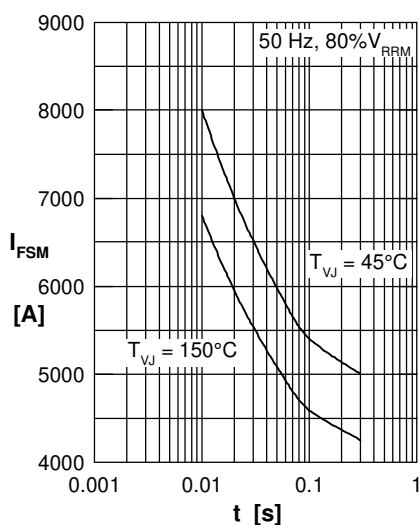


Fig. 2 Surge overload current vs. time per diode

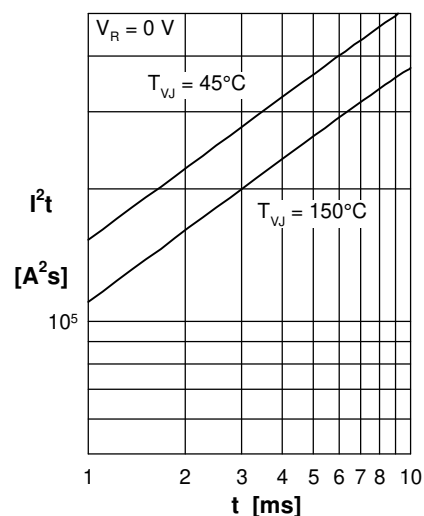
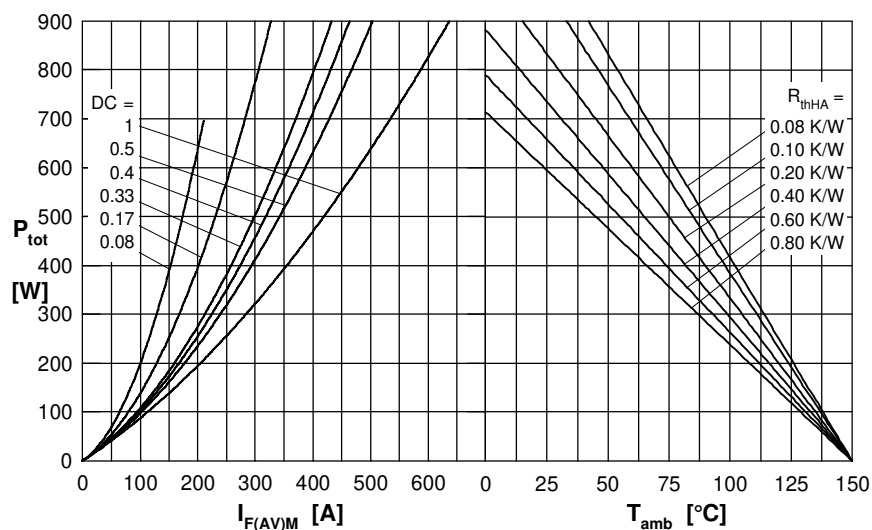

 Fig. 3  $I^2t$  versus time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

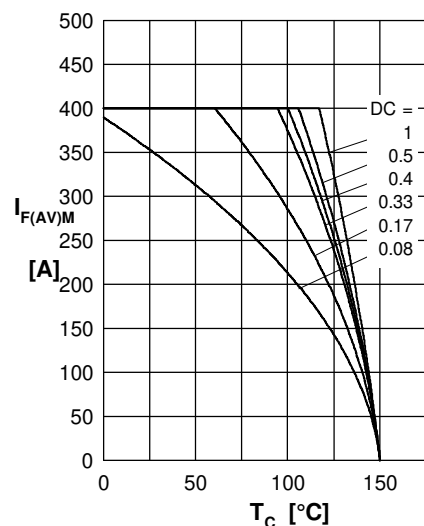


Fig. 5 Max. forward current vs. case temperature per diode

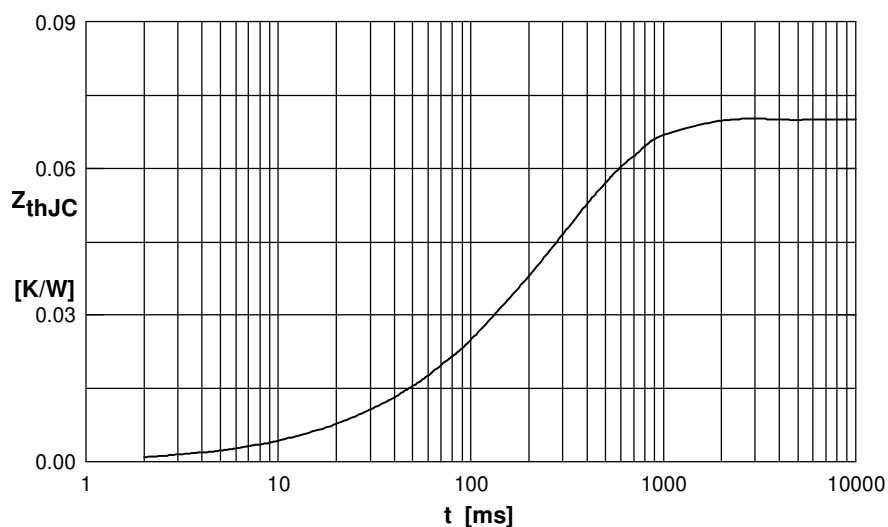


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.003           | 0.0150    |
| 2 | 0.009           | 0.0800    |
| 3 | 0.016           | 0.2200    |
| 4 | 0.042           | 0.3800    |